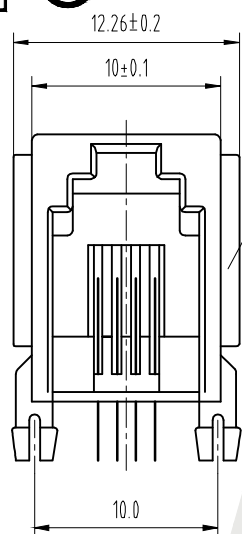
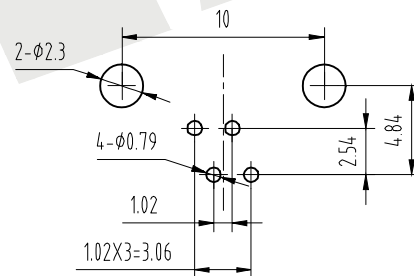
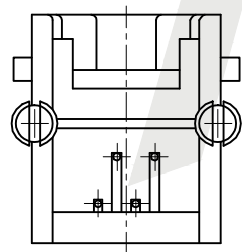
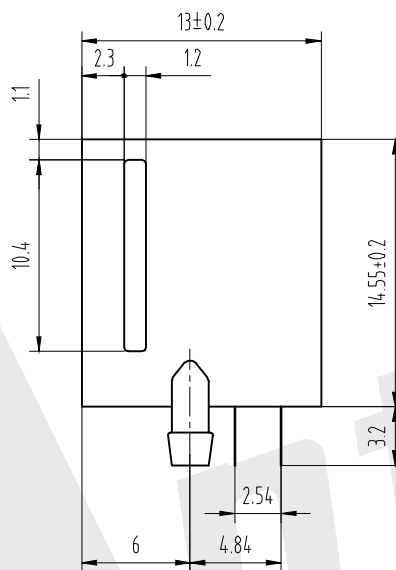


HSF



Panel



PC Board Layout
Component Side Shown

NOTES:

MATERIAL:

1. HOUSING MATERIAL: GLASS FILLED POYESTER UL94V-0.
2. CONTACT MATERIAL: PHOSPHOR BRONZE $t=0.3\text{mm}$
3. PLATING: SELECTING GOLD PLATING $1\mu\sim 50\mu$ OVER NICKEL IN CONTACT AREA. 150μ TIN PLATIN. OVER NICKEL IN SOLDER AREA
4. SHIELD: 0.2mm THICKNESS COPPER WITH NICKEL PLATE

ELECTRICAL

1. VOLTAGE RATING: 125VAC RMS
2. CURRENT RATING: 1.5AMP
3. CONTACT RESISTANCE: 30MILLIOHMS MAX
4. INSULATION RESISTANCE 500MEGOHMS MIN @500V DC
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN

MECHANICAL

1. DURRABILITY: 750 CYCLES MIN
2. PCB RETENTTON PRB-SOLDER: 1 LB MIN

REVIROMENTAL

1. STORAGE: -40°C TO 85°C
2. OPERATION: 0°C TO 70°C

Order code:

ATRJ5521 - 4P - 4C - X - A - A

① ② ③ ④ ⑤ ⑥

① SERIES NO:

② NUMBER OF POSITIONS (8P, 6P, 4P)

③ NUMBER OF CONTACTS (8C, 6C, 4C)

④ Contact Plating

G0: GOLD flash

G1: 30U" Gold

G2: 50U" Gold

G3: 100U" Gold

G4: 150U" Gold

G5: 300U" Gold

SN: Tin

⑤ Shield

A: W/O Shield

B: Half Shield

C: Shield W/Eml

D: Shield W/O Eml

⑥ With Panel or not

A: With panel

B: Without panel

Unless Otherwise specified tolerance

X. ± 0.35

X.XX: ± 0.20

X.X: ± 0.25

X.XXX: ± 0.15

SCALE:

As Shown

UNIT:

mm

DRAW

Wu Feng Rong

DATE

05/09/2019

CHECK

BobYang

DATE

05/09/2019



ANTENK ELECTRONICS CO., LTD

Http://www.antenk.com

E-mail:sales@antenk.com

TITLE:

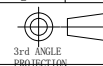
RJ11 Jack side entry, Full plastic with panel

DRAWING NO:

ATRJ5521-4P4C-X-A-A

PRODUCT NO:

ATRJ5521-4P4C-X-A-A



3rd ANGLE
PROJECTION

D

D

REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		